AMENDMENTS TO THE CLAIMS:

1. (Currently Amended) A method for carbon nanotube emitter surface treatment, which is used on a carbon nanotube electronic ~~electronics~~ source for increasing the number of carbon nanotubes ~~nanotube~~ exposed on a triode structure or ~~any~~ other surface structure of a carbon nanotube field emission display (CNT-FED), ~~CNT-FED, then the method can advance the current density and intensity of CNT emitter,~~ the method for carbon nanotube emitter surface treatment comprising the steps of:

coating an adhesive material on the surface of said CNT-FED;

heating said adhesive material for adhibitting the surface of said CNT-FED; and

removing impurities on the surface of said CNT-FED by lifting said adhesive material off.

2. (Currently Amended) The method for carbon nanotube emitter surface treatment as ~~recited~~ claimed in claim 1, wherein said adhesive material is selected from the group consisting of a hot melt glue, ~~or~~ a soluble material, an organic material, an inorganic material and a strippable material.

3. (Currently Amended) The method for carbon nanotube emitter surface treatment as ~~recited~~ claimed in claim 1, wherein said adhesive material sticks on said carbon nanotube electronic ~~electronics~~ source.

4. (Currently Amended) The method for carbon nanotube emitter surface treatment as ~~recited~~ claimed in claim 3, wherein said carbon nanotube electronic source is set between a cathode plate and a gate ~~existed~~ in said triode structure.

5. (Currently Amended) A method for carbon nanotube emitter surface treatment, which is used on a carbon nanotube electronic ~~electronics~~ source for increasing the number of carbon nanotubes ~~nanotube~~ exposed on a triode structure or ~~any~~ other surface structure of a carbon nanotube field emission display (CNT-FED), ~~CNT-FED, then the method can advance the current density and intensity of CNT emitter,~~ the method for carbon nanotube emitter surface treatment comprising the steps of:

coating an activator on the surface of said CNT-FED;

coating an adhesive material on said activator;

pressing said adhesive material for adhibitting the surface; and

removing impurities on the surface of said CNT-FED by lifting said adhesive material off.

6. (Currently Amended) The method for carbon nanotube emitter surface treatment as ~~recited~~ claimed in claim 5, wherein said activator is an interface activator, a [[,]] surfactant or a release agent.

7. (Currently Amended) The method for carbon nanotube emitter surface treatment as ~~recited~~ claimed in claim 5, wherein said adhesive material is selected from the group consisting of a hot melt glue, ~~or~~ a soluble material, an organic material, an inorganic material and a strippable material.

8. (Currently Amended) The method for carbon nanotube emitter surface treatment as ~~recited~~ claimed in claim 5, wherein said step of pressing said adhesive material for adhibitting the surface of said CNT-FED is achieved by a pressing machine.

9. (Currently Amended) The method for carbon nanotube emitter surface treatment as

~~recited~~ claimed in claim 5, wherein said adhesive material sticks on said carbon nanotube electronic ~~electronics~~ source.

10. (Currently Amended) The method for carbon nanotube emitter surface treatment as ~~recited~~ claimed in claim 9, wherein said carbon nanotube electronic source is set between a cathode plate and a gate ~~existed~~ in said triode structure.